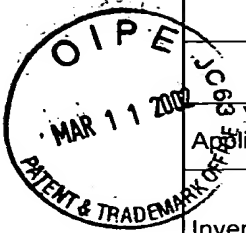


2818

#8



| <b>AMENDMENT TRANSMITTAL LETTER</b>  |   |   |                                   | Docket No.<br>TESSERA 3.0-081 DIV CONT |      |
|--|---|---|-----------------------------------|--|------|
| Application No.<br>09/638,079  | Filing Date<br>August 14, 2000            | Examiner<br>Phuc T. Dang                | Art Unit<br>2818                  |  |      |
| Applicant(s): Thomas H. DiStefano and Joseph Fjelstad  |   |   |                                   |  |      |
| Invention: METHODS FOR PROVIDING VOID-FREE LAYERS FOR SEMICONDUCTOR ASSEMBLIES   |   |   |                                   |  |      |
| <b>TO THE COMMISSIONER FOR PATENTS</b>   |   |   |                                   |  |      |
| Transmitted herewith is an amendment in the above-identified application.  |   |   |                                   |  |      |
| The fee has been calculated and is transmitted as shown below.   |   |   |                                   |  |      |
| <b>CLAIMS AS AMENDED</b>   |   |   |                                   |  |      |
|  | Claims<br>Remaining<br>After<br>Amendment | Highest<br>Number<br>Previously<br>Paid | Number<br>Extra Claims<br>Present | Rate                                   |      |
| <b>Total Claims</b>  | 40  | - 40 =                                  |                                   | x                                      | 0.00 |
| <b>Independent Claims</b>  | 8   | - 8 =                                   |                                   | x                                      | 0.00 |
| Multiple Dependent Claims (check if applicable) <input type="checkbox"/>   |   |   |                                   |  |      |
| Other fee (please specify):  |   |   |                                   |  |      |
| <b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:</b>  |   |   |                                   |  | 0.00 |
| <input checked="" type="checkbox"/> Large Entity <span style="margin-left: 200px;"><input type="checkbox"/> Small Entity</span>  |   |   |                                   |  |      |
| <input checked="" type="checkbox"/> No additional fee is required for this amendment.  |   |   |                                   |  |      |
| <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____.<br>A duplicate copy of this sheet is enclosed.   |   |   |                                   |  |      |
| <input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.  |   |   |                                   |  |      |
| <input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge and credit Deposit Account No. <u>12-1095</u><br>as described below. A duplicate copy of this sheet is enclosed.   |   |   |                                   |  |      |
| <input checked="" type="checkbox"/> Credit any overpayment.  |   |   |                                   |  |      |
| <input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.   |   |   |                                   |  |      |
| Kimberly V. Perry<br>Attorney Reg. No.: 43,612   |   |   |                                   | Dated: <u>February 28, 2002</u>        |      |
| LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP<br>600 South Avenue West<br>Westfield, New Jersey 07090<br>(908) 518-6361   |   |   |                                   |  |      |
| I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below. |   |   |                                   |  |      |
| Dated: February 28, 2002   |   |   | Signature:  Kimberly V. Perry)    |  |      |

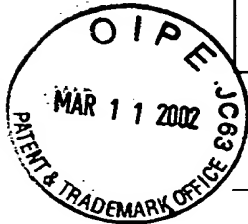
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: February 28, 2002 Signature: *[Signature]*

(Kimberly V. Perry)

Docket No.: TESSERA 3.0-081 DIV CONT  
(PATENT)

#8/Reg for  
Recons.  
UBM  
3/20/02



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
*DiStefano et al.*

Application No.: 09/638,079

Filed: August 14, 2000

For: METHODS FOR PROVIDING VOID-FREE  
LAYERS FOR SEMICONDUCTOR  
ASSEMBLIES

Group Art Unit: 2818

Examiner: Phuc T. Dang

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Commissioner for Patents  
Washington, DC 20231

AMENDMENT

Dear Sir:

In response to the Official Action, in which Claims 2-10 and 22-30 were rejected,  
Applicants submit the following remarks.